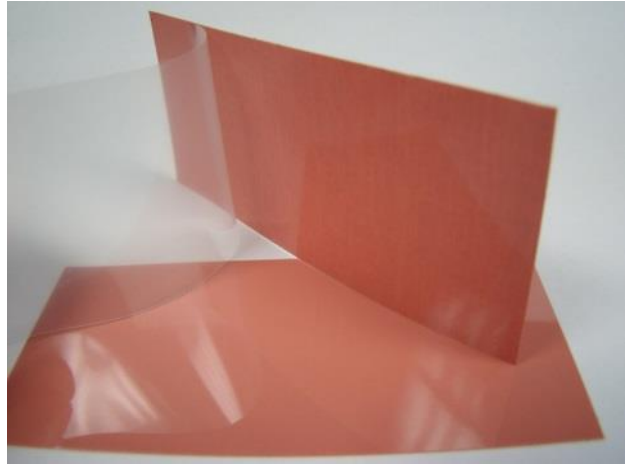


Thermally conductive adhesive tapes are used for bonding heatsinks or other cooling devices to the hot device.

The adhesive tapes are supplied as double sided adhesive film and are filled with ceramic particles.

Thermally conductive tapes eliminate the need for external clamps and curing.

- Thermal conductivity: 2,0 W/m\*K
- Available in 400x300 mm standard sheet size, other dimensions and die-cut parts on request
- Available in thicknesses from 0,3 to 2,0 mm
- Double-sided, pressure sensitive adhesive
- Thermal conductivity in combination with electrical isolation
- High temperature stability



## PRODUCT SPECIFICATIONS

PROPERTY	VALUE / TOLERANCE	TEST METHOD
Thermal conductivity	2,0 W/m*K	ASTM D5470
Hardness	60 Shore 00	ASTM D2240
Material	Silicone-based polymer	-
Filler	Ceramic powder	-
Adhesive Type	Acrylic Powder	-
Surface adhesion	8,8 @ 23°, N/25mm	PSTC-7
Temperature range	-60 – 150 °C	-
Breakdown voltage	>5 kV/mm	ASTM D149
Density	2,6 g/cm <sup>3</sup>	-
Thickness & carrier	12mil-80mil (1mil=0,0254mm)	ASTM D3652
	0,3mm-2,0mm	
Standard sheet size (LxW)	400x300 mm	
Shelf life°	12 months	

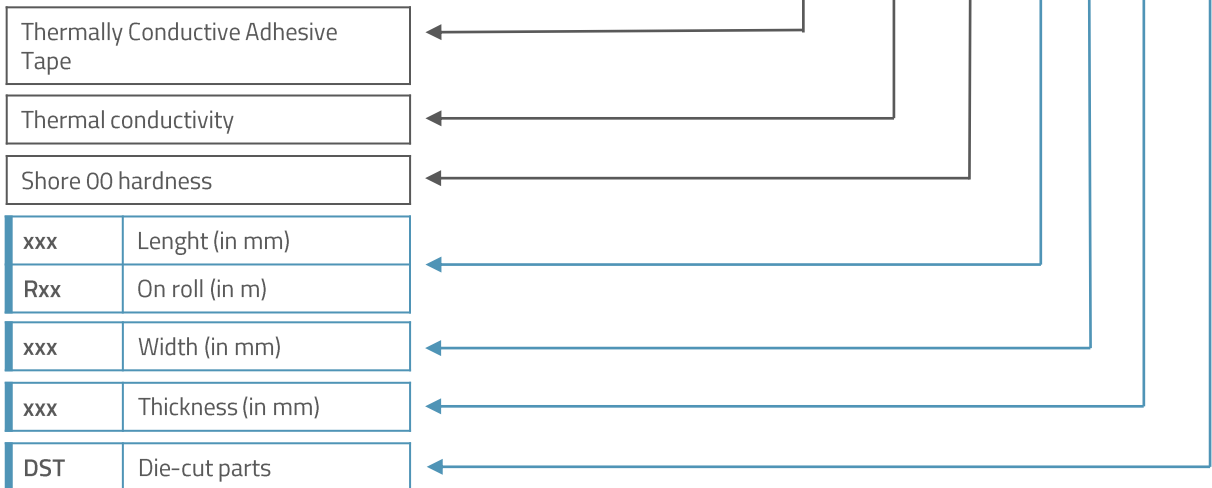
°From date of receipt by the customer when stored at 23°C / 60%rH

Please note: Picture only shows an example of a phase change material.

Modifications and errors excepted. The information and statements herein are believed to be reliable but are not to be construed as a warranty or representation for which we assume legal responsibility. Users should undertake sufficient verifications and testings to determine the suitability for their own particular purpose of any information or products referred to herein.

**BUILDING AN ITEM NUMBER**

**TCAT-2,0 S60-LxWxT-XXX**



**Standard options**

**EXAMPLE**

TCAT-2,0 S60-27x25x0,3-DST  
Thermally conductive adhesive tape; thermal conductivity: 2,0 W/m\*K; hardness: 60 Shore 00; size: 27x25 mm; thickness: 0,3 mm; die-cut

**CONFIGURATIONS AVAILABLE**

- Standard sheet size: 400x300 mm
- Customer-specific sheet sizes
- Die-cut parts
- On roll

**THERMAL IMPEDANCE**

